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(54) **ORGANIC LIGHT-EMITTING DISPLAY APPARATUS AND METHOD OF MANUFACTURING THE SAME**

(58) **Field of Classification Search**
CPC .. H01L 51/5218; H01L 51/5215; H01L 51/56;
H01L 51/5221
See application file for complete search history.

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(57) **ABSTRACT**

(51) **Int. Cl.**
H01L 51/52 (2006.01)

Provided is an organic light-emitting display apparatus including a substrate; a first electrode formed on the substrate; an emission layer formed on the first electrode; and a second electrode formed on the emission layer, wherein the first electrode includes a first layer including silver (Ag); and a second layer disposed on the first layer and comprising oxide of non-silver metal.

(52) **U.S. Cl.**
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19 Claims, 6 Drawing Sheets

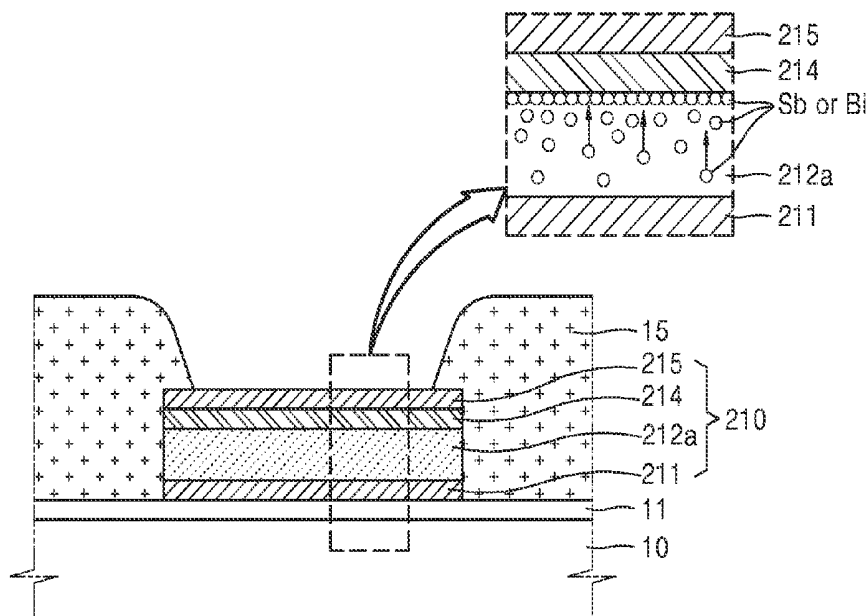


FIG. 1

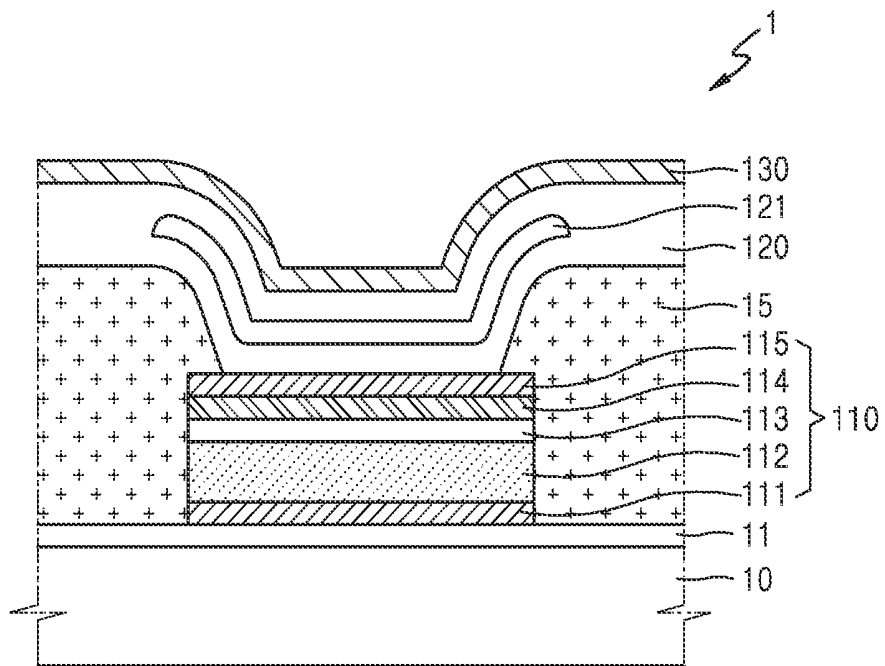


FIG. 2A

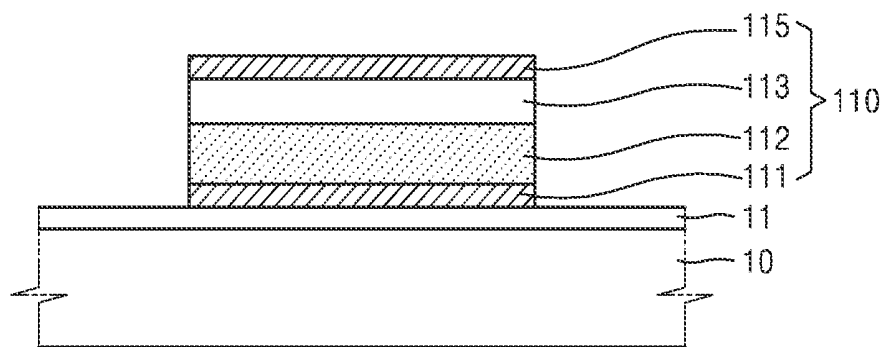


FIG. 2B

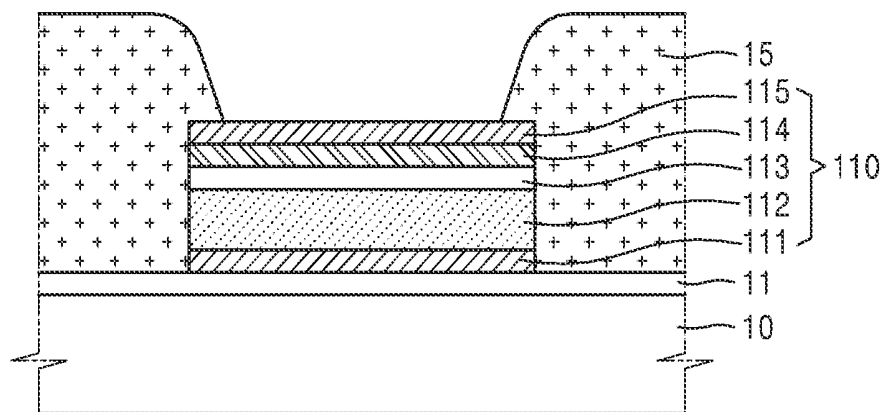


FIG. 3A

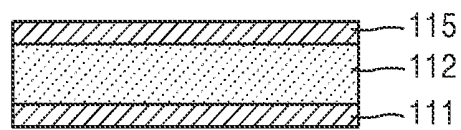


FIG. 3B

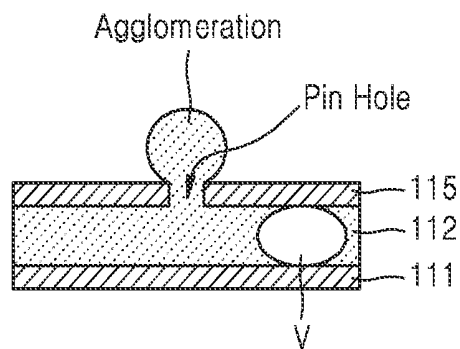


FIG. 4

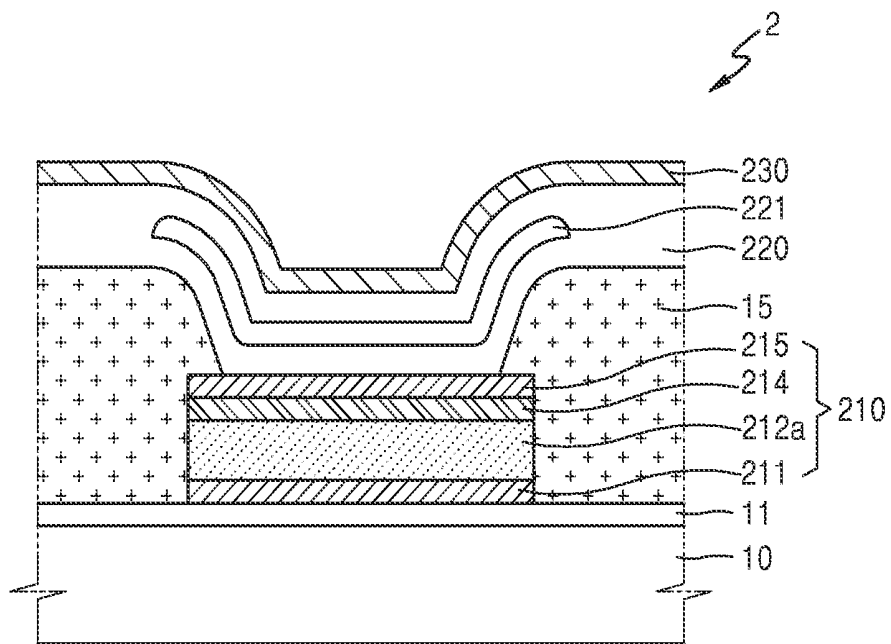


FIG. 5A

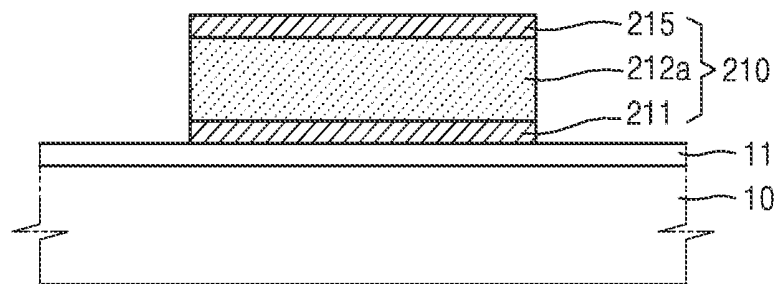


FIG. 5B

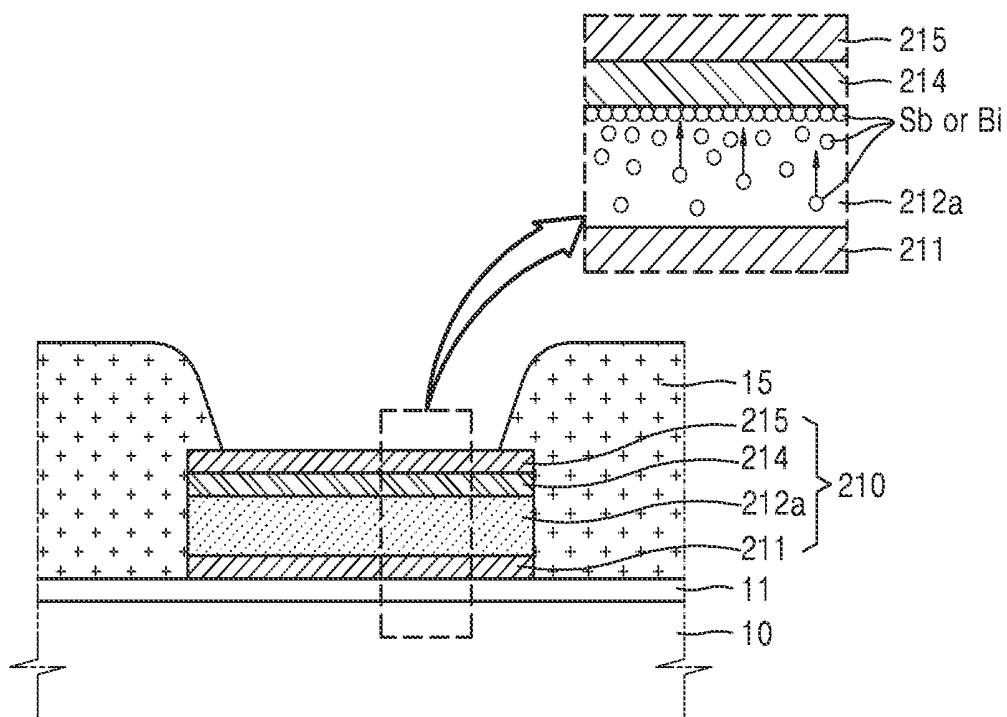
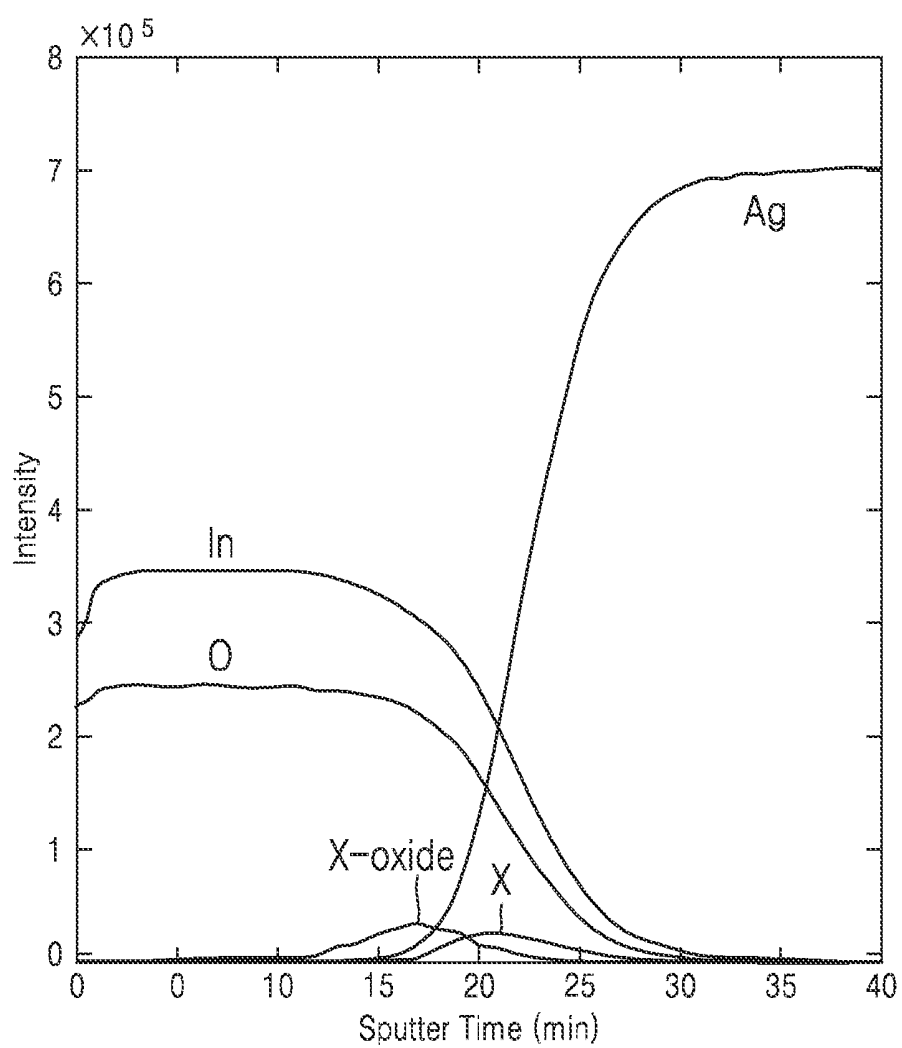


FIG. 6



ORGANIC LIGHT-EMITTING DISPLAY APPARATUS AND METHOD OF MANUFACTURING THE SAME

CROSS-REFERENCE TO RELATED APPLICATION

This application claims priority from and the benefit of Korean Patent Application No. 10-2014-0170828, filed on Dec. 2, 2014, which is hereby incorporated by reference for all purposes as if fully set forth herein.

BACKGROUND

Field

Exemplary embodiments relate to an organic light-emitting display apparatus and a method of manufacturing the same.

Discussion of the Background

An organic light-emitting display apparatus is a self-emissive display apparatus including a hole injection electrode and an electron injection electrode, and an emission layer formed therebetween, in which holes injected from the hole injection electrode and electrons injected from the electron injection electrode are re-combined in the emission layer so that light is emitted therefrom. The organic light-emitting display apparatus is expected to become a next generation display apparatus due to its high quality characteristic such as low power consumption, high contrast, a fast response time, etc.

SUMMARY

Exemplary embodiments provide an organic light-emitting display apparatus having an improved yield rate and manufacturing method thereof.

Additional aspects will be set forth in the detailed description which follows, and, in part, will be apparent from the disclosure, or may be learned by practice of the inventive concept.

According to exemplary embodiments, an organic light-emitting display apparatus includes a substrate; a first electrode formed on the substrate; an emission layer formed on the first electrode; and a second electrode formed on the emission layer, wherein the first electrode includes a first layer including silver (Ag); and a second layer disposed on the first layer and including an oxide of a non-silver metal.

The non-silver metal may include at least one selected from antimony (Sb) and bismuth (Bi).

The organic light-emitting display apparatus may further include a third layer that is formed between the first layer and the second layer and includes the non-silver metal corresponding to the oxide of the non-silver metal included in the second layer.

The organic light-emitting display apparatus may further include a first protective layer that is formed between the substrate and the first layer and includes transparent conductive oxide.

The first protective layer may include at least one material selected from the group consisting of indium tin oxide (ITO), indium zinc oxide (IZO), zinc oxide (ZnO), indium oxide (In_2O_3), indium gallium oxide (IGO), and aluminum zinc oxide (AZO).

The organic light-emitting display apparatus may further include a second protective layer that is formed between the second layer and the emission layer and includes transparent conductive oxide.

The second protective layer may include at least one material selected from the group consisting of ITO, IZO, ZnO, In_2O_3 , IGO, and AZO.

The first layer may comprise the silver and the non-silver metal alloy, and the non-silver metal may include at least one selected from antimony (Sb) and bismuth (Bi).

The second electrode may be a reflective electrode.

Light that is emitted from the emission layer may be discharged toward the substrate.

The second electrode may be a transparent electrode.

Light that is emitted from the emission layer may be discharged away from the substrate.

The first electrode may be an anode, and the second electrode may be a cathode.

According to another exemplary embodiments, a method of manufacturing an organic light-emitting display apparatus includes operations of forming a layer including silver on a substrate; forming a layer including a non-silver metal on the layer including silver; forming a protective layer including transparent conductive oxide on the layer including the non-silver metal; forming an emission layer on the protective layer; forming a second electrode on the emission layer; and forming, by performing a thermal treatment, a layer including an oxide of the non-silver metal between the protective layer and the layer including the non-silver metal.

The layer including the non-silver metal may include at least one selected from antimony (Sb) and bismuth (Bi).

The method may further include an operation of forming a layer including a transparent conductive oxide between the substrate and the layer including silver.

According to one another exemplary embodiments, a method of manufacturing an organic light-emitting display apparatus includes operations of forming a layer including an alloy of silver and a non-silver metal on a substrate; forming a protective layer including a transparent conductive oxide on the layer including the alloy; forming an emission layer on the protective layer; forming a second electrode on the emission layer; and forming, by performing a thermal treatment, a layer including an oxide of the non-silver metal between the protective layer and the layer including the alloy.

The non-silver metal of the alloy may include at least one selected from antimony (Sb) and bismuth (Bi).

The method may further include an operation of forming a layer including a transparent conductive oxide between the substrate and the layer including the alloy.

The foregoing general description and the following detailed description are exemplary and explanatory and are intended to provide further explanation of the claimed subject matter.

BRIEF DESCRIPTION OF THE DRAWINGS

The accompanying drawings, which are included to provide a further understanding of the inventive concept, and are incorporated in and constitute a part of this specification, illustrate exemplary embodiments of the inventive concept, and, together with the description, serve to explain principles of the inventive concept.

FIG. 1 is a cross-sectional view of an organic light-emitting display apparatus according to a first exemplary embodiment.

FIGS. 2A and 2B are cross-sectional views that partly illustrate a method of manufacturing the organic light-emitting display apparatus of the first exemplary embodiment.

FIGS. 3A and 3B are cross-sectional views of an anode structure, according to a comparative example.

FIG. 4 is a cross-sectional view of an organic light-emitting display apparatus according to a second exemplary embodiment.

FIGS. 5A and 5B are cross-sectional views that partly illustrate a method of manufacturing the organic light-emitting display apparatus of the second exemplary embodiment.

FIG. 6 is a graph that shows intensities of components in a first electrode according to a sputtering time of the organic light-emitting display apparatus shown in FIG. 1.

DETAILED DESCRIPTION OF THE ILLUSTRATED EMBODIMENTS

In the following description, for the purposes of explanation, numerous specific details are set forth in order to provide a thorough understanding of various exemplary embodiments. It is apparent, however, that various exemplary embodiments may be practiced without these specific details or with one or more equivalent arrangements. In other instances, well-known structures and devices are shown in block diagram form in order to avoid unnecessarily obscuring various exemplary embodiments.

In the accompanying figures, the size and relative sizes of layers, films, panels, regions, etc., may be exaggerated for clarity and descriptive purposes. Also, like reference numerals denote like elements.

When an element or layer is referred to as being “on,” “connected to,” or “coupled to” another element or layer, it may be directly on, connected to, or coupled to the other element or layer or intervening elements or layers may be present. When, however, an element or layer is referred to as being “directly on,” “directly connected to,” or “directly coupled to” another element or layer, there are no intervening elements or layers present. For the purposes of this disclosure, “at least one of X, Y, and Z” and “at least one selected from the group consisting of X, Y, and Z” may be construed as X only, Y only, Z only, or any combination of two or more of X, Y, and Z, such as, for instance, XYZ, XYY, YZ, and ZZ. Like numbers refer to like elements throughout. As used herein, the term “and/or” includes any and all combinations of one or more of the associated listed items.

Although the terms first, second, etc. may be used herein to describe various elements, components, regions, layers, and/or sections, these elements, components, regions, layers, and/or sections should not be limited by these terms. These terms are used to distinguish one element, component, region, layer, and/or section from another element, component, region, layer, and/or section. Thus, a first element, component, region, layer, and/or section discussed below could be termed a second element, component, region, layer, and/or section without departing from the teachings of the present disclosure.

Spatially relative terms, such as “beneath,” “below,” “lower,” “above,” “upper,” and the like, may be used herein for descriptive purposes, and, thereby, to describe one element or feature’s relationship to another element(s) or feature(s) as illustrated in the drawings. Spatially relative terms are intended to encompass different orientations of an apparatus in use, operation, and/or manufacture in addition to the orientation depicted in the drawings. For example, if the apparatus in the drawings is turned over, elements described as “below” or “beneath” other elements or features would then be oriented “above” the other elements or

features. Thus, the exemplary term “below” can encompass both an orientation of above and below. Furthermore, the apparatus may be otherwise oriented (e.g., rotated 90 degrees or at other orientations), and, as such, the spatially relative descriptors used herein interpreted accordingly.

The terminology used herein is for the purpose of describing particular embodiments and is not intended to be limiting. As used herein, the singular forms, “a,” “an,” and “the” are intended to include the plural forms as well, unless the context clearly indicates otherwise. Moreover, the terms “comprises,” “comprising,” “includes,” and/or “including,” when used in this specification, specify the presence of stated features, integers, steps, operations, elements, components, and/or groups thereof, but do not preclude the presence or addition of one or more other features, integers, steps, operations, elements, components, and/or groups thereof.

Various exemplary embodiments are described herein with reference to sectional illustrations that are schematic illustrations of idealized exemplary embodiments and/or intermediate structures. As such, variations from the shapes of the illustrations as a result, for example, of manufacturing techniques and/or tolerances, are to be expected. Thus, exemplary embodiments disclosed herein should not be construed as limited to the particular illustrated shapes of regions, but are to include deviations in shapes that result from, for instance, manufacturing. For example, an implanted region illustrated as a rectangle will, typically, have rounded or curved features and/or a gradient of implant concentration at its edges rather than a binary change from implanted to non-implanted region. Likewise, a buried region formed by implantation may result in some implantation in the region between the buried region and the surface through which the implantation takes place. Thus, the regions illustrated in the drawings are schematic in nature and their shapes are not intended to illustrate the actual shape of a region of a device and are not intended to be limiting.

Unless otherwise defined, all terms (including technical and scientific terms) used herein have the same meaning as commonly understood by one of ordinary skill in the art to which this disclosure is a part. Terms, such as those defined in commonly used dictionaries, should be interpreted as having a meaning that is consistent with their meaning in the context of the relevant art and will not be interpreted in an idealized or overly formal sense, unless expressly so defined herein.

FIG. 1 is a cross-sectional view of an organic light-emitting display apparatus 1 according to a first exemplary embodiment.

Referring to FIG. 1, a buffer layer 11, a first electrode 110, an intermediate layer 120 including an emission layer 121, and a second electrode 130 are arranged on a substrate 10 of the organic light-emitting display apparatus 1 according to the first exemplary embodiment. That is, the buffer layer 11, the first electrode 110, the intermediate layer 120 including the emission layer 121, and the second electrode 130 may be sequentially stacked on the substrate 10.

The substrate 10 may be formed as a transparent substrate including a glass substrate or a plastic substrate including polyethylene terephthalate (PET), polyethylene naphthalate (PEN), polyimide, or the like.

The buffer layer 11 may be further arranged on the substrate 10 so as to form a planar surface on the substrate 10 and to prevent penetration of foreign substances. The buffer layer 11 may be formed as a single layer or multiple layers including silicon nitride and/or silicon oxide.

Although not illustrated in FIG. 1, a plurality of thin-film transistors (TFTs) may be arranged between the buffer layer 11 and the first electrode 110. A driving TFT of the plurality of TFTs may apply current to the first electrode 110, and thus, drives an organic light-emitting device in each pixel. Specifically, the organic light-emitting display apparatus 1 may include a plurality of pixels, and each of the pixels may have the driving TFT and the organic light-emitting device.

In the present embodiment, the first electrode 110 includes a first protective layer 111, a first layer 112, a third layer 113, a second layer 114, and a second protective layer 115.

The first layer 112 may be formed as a transfective metal layer including silver (Ag) or a silver alloy and having a thickness between about 100 and about 300 Å.

The first protective layer 111 including transparent conductive oxide may be formed between the buffer layer 11 and the first layer 112.

The first protective layer 111 may include at least one material selected from the group consisting of indium tin oxide (ITO), indium zinc oxide (IZO), zinc oxide (ZnO), indium oxide (In₂O₃), indium gallium oxide (IGO), and aluminum zinc oxide (AZO).

The first protective layer 111 may reinforce adhesion between the first layer 112 and the buffer layer 11, and may prevent impurity from diffusing to the first layer 112.

Referring to FIG. 1, the first protective layer 111 directly contacts the buffer layer 11, but one or more exemplary embodiments are not limited thereto. For example, the buffer layer 11 and a plurality of insulating layers may be formed between the substrate 10 and the first protective layer 111, and the first protective layer 111 may directly contact one of the plurality of insulating layers.

The third layer 113 including a non-silver metal may be formed on the first layer 112.

The metal for forming the third layer 113 may be easily oxidized than silver and may have an atomic radius that is less than or is similar to an atomic radius of silver. The third layer 113 may be formed of the metal including at least one selected from antimony (Sb) and bismuth (Bi).

The second layer 114 including oxide of the metal included in the third layer 113 is formed on the third layer 113. For example, the second layer 114 may be formed of antimony oxide (SbOx) or bismuth oxide (BiOx). That is, the second layer 114 is an oxide layer of the third layer 113. The second layer 114 prevents the first layer 112 including silver from agglomerating on the second protective layer 115. Detailed descriptions thereof will be provided later.

The second protective layer 115 is formed on the second layer 114. The second protective layer 115 may include transparent conductive oxide. The second protective layer 115 may include at least one material selected from the group consisting of ITO, IZO, ZnO, In₂O₃, IGO, and AZO.

The second protective layer 115 protects the first layer 112 including silver. Also, since the second protective layer 115 is formed of transparent conductive oxide having a high work function, the first electrode 110 including the second protective layer 115 may be used as an anode having a high efficiency.

A pixel defining layer 15 covers edges of the first electrode 110. The pixel defining layer 15 may be formed as an organic insulating layer including polymer derivatives having commercial polymers (PMMA and PS) and a phenol group, an acryl-based polymer, an imide-based polymer, an allyl ether-based polymer, an amide-based polymer, a fluorine-based polymer, a p-xylene-based polymer, a vinyl alcohol-based polymer, or a combination thereof.

The intermediate layer 120 including the emission layer 121 is formed on the first electrode 110.

The emission layer 121 may include a small molecule organic material or a polymer organic material.

If the emission layer 121 includes the small molecule organic material, the intermediate layer 120 may further include a hole transport layer (HTL), a hole injection layer (HIL), an electron transport layer (ETL), or an electron injection layer (EIL). In addition to these layers, if required, the intermediate layer may further include various layers. Here, various organic materials including copper phthalocyanine (CuPc), N'-Di(naphthalene-1-yl)-N,N'-diphenylbenzidine (NPB), tris-8-hydroxyquinoline aluminum (Alq3), or the like may be used.

If the emission layer 121 includes the polymer organic material, the intermediate layer 120 may further include an HTL. The HTL may be formed of poly-(2,4)-ethylene-dihydroxy thiophene (PEDOT) or polyaniline (PANI). Here, the polymer organic material may include poly-phenylene vinylene (PPV), polyfluorene, or the like. Also, an inorganic material may be further arranged between the emission layer 121 and the first electrode 110 and may be further arranged between the emission layer 121 and the second electrode 130.

The second electrode 130 that is commonly formed in pixels is arranged on the emission layer 121. In the organic light-emitting display apparatus 1 according to the present embodiment, the first electrode 110 is used as an anode and the second electrode 130 is used as a cathode but polarities of electrodes may be switched.

The second electrode 130 may include at least one material selected from Al, Mg, Li, Ca, LiF/Ca, and LiF/Al.

As described above, since the first electrode 110 including the first layer 112 is formed as a transfective metal layer, and the second electrode 130 is formed as a reflective electrode, the organic light-emitting display apparatus 1 may be manufactured as a bottom emission type organic light-emitting display apparatus. That is, light that is emitted from the emission layer 121 may be discharged toward the substrate 10. Here, the first electrode 110 and the second electrode 130 may form a micro-cavity structure and thus may improve a luminescent efficiency of the organic light-emitting display apparatus 1.

Since the first layer 112 is formed as a layer including silver or a silver alloy with a thickness equal to or greater than 500 Å, the first layer 112 may be arranged as a reflective metal layer. That is, if the first electrode 110 including the first layer 112 is formed as a reflective layer, and the second electrode 130 is formed as a transparent electrode, the organic light-emitting display apparatus 1 may be manufactured as a top emission type organic light-emitting display apparatus. That is, light that is emitted from the emission layer 121 may be discharged away from the substrate 10.

FIGS. 2A and 2B are cross-sectional views that partly illustrate a method of manufacturing the organic light-emitting display apparatus 1 of the first exemplary embodiment.

Referring to FIG. 2A, the buffer layer 11 is formed on the substrate 10. A layer including transparent conductive oxide, a layer including silver, a layer including a non-silver metal, and another layer including transparent conductive oxide are sequentially deposited on the buffer layer 11, and are patterned using a same mask, so that the first electrode 110 including the first protective layer 111, the first layer 112, the third layer 113, and the second protective layer 115 is formed.

Each of the first protective layer **111** and the second protective layer **115** may include at least one material selected from the group consisting of ITO, IZO, ZnO, In₂O₃, IGO, and AZO. In an early stage of forming the first electrode **110**, each of the first protective layer **111** and the second protective layer **115** has an amorphous structure.

The metal used for the third layer **113** may be easily oxidized than silver and may have an atomic radius that is less than or is similar to an atomic radius of silver. The third layer **113** may be formed of the metal including at least one selected from Sb and Bi.

Referring to FIG. 2B, an organic insulating layer is patterned to form the pixel defining layer **15** covering the edges of the first electrode **110**. A thermal treatment process such as a curing when forming the pixel defining layer **15** oxidizes the metal included in the third layer **113** naturally. This forms the second layer **114**, which is the oxidized layer of the third layer **113**, between the third layer **113** and the second protective layer **115**.

FIGS. 3A and 3B are cross-sectional views of an anode structure, according to a comparative example.

Referring to FIGS. 3A and 3B, the anode structure according to the comparative example includes a first protective layer **111**, a first layer **112**, and a second protective layer **115**. That is, the anode structure according to the comparative example does not include the third layer **113**, the second layer **114**.

As shown in FIG. 3A, a transparent conductive oxide included in the second protective layer **115** is amorphous in an initial stage of forming an anode structure. Afterward, however, the transparent conductive oxide included in the second protective layer **115** goes through a thermal treatment process to crystallize into a polycrystalline transparent conductive oxide, and a pin hole is formed in a surface of the second protective layer **115**. Silver or a silver alloy of the first layer **112** under the pin hole forms a void V in the first layer **112**, and silver effuses through the pin hole in the surface of the second protective layer **115**, such that agglomeration of silver occurs on the second protective layer **115**. The agglomeration of silver causes a dark spot defect in an organic light-emitting display apparatus.

However, in the organic light-emitting display apparatus **1** according to the present embodiment, as illustrated in FIG. 1, the third layer **113** that does not include silver, and the second layer **114** that is an oxidized layer of the third layer **113** are further formed on the first layer **112** including silver, so that the third layer **113** and the second layer **114** prevent effusion of the first layer **112** including silver through the surface of the second protective layer **115**.

Since silver is highly reducible, it is difficult to form an oxide layer on its surface. In the present embodiment, the third layer **113** including at least one selected from Sb and Bi of the group 15 elements that are easily oxidized than silver and are usable as display apparatus electrodes is formed on the first layer **112** including silver, and then the third layer **113** is oxidized to form the second layer **114** that is an oxide layer. The second layer **114**, the oxide layer, prevents silver from effusing through the surface of the second protective layer **115**.

FIG. 4 is a cross-sectional view of an organic light-emitting display apparatus **2** according to a second exemplary embodiment.

Referring to FIG. 4, a buffer layer **11**, a first electrode **210**, an intermediate layer **220** including an emission layer **221**, and a second electrode **230** are arranged on a substrate **10** of the organic light-emitting display apparatus **2** according to the second exemplary embodiment.

Hereinafter, the second exemplary embodiment is described focusing on differences from the first exemplary embodiment. Like reference numerals denote like elements.

The substrate **10** may be formed as a transparent substrate including a glass substrate or a plastic substrate including polyethylene terephthalate (PET), polyethylene naphthalate (PEN), polyimide, or the like.

The buffer layer **11** may be further arranged on the substrate **10** so as to form a planar surface on the substrate **10** and to prevent penetration of foreign substances. The buffer layer **11** may be formed as a single layer or multiple layers including silicon nitride and/or silicon oxide.

In the present embodiment, the first electrode **210** includes a first protective layer **211**, a first layer **212a**, a second layer **214**, and a first protective layer **215**.

The first protective layer **211** including transparent conductive oxide may be formed between the buffer layer **11** and the first layer **212a**. The first protective layer **211** may reinforce adhesion between the first layer **212a** and the buffer layer **11**, and may prevent impurity from diffusing from the substrate **10** to the first layer **212a**.

Referring to FIG. 4, the first protective layer **211** directly contacts the buffer layer **11**, but one or more exemplary embodiments are not limited thereto. For example, the buffer layer **11** and a plurality of insulating layers may be formed between the substrate **10** and the first protective layer **211**, and the first protective layer **211** may directly contact one of the plurality of insulating layers.

The first layer **212a** is formed on the first protective layer **211**. The first layer **212a** may be formed as a transmissive metal layer that includes a silver and non-silver metal alloy and has a thickness between about 100 and about 300 Å.

Here, a metal forming the first layer **212a** may be easily oxidized than silver and may have an atomic radius that is less than or is similar to an atomic radius of silver. The first layer **212a** may be formed of the metal including at least one selected from Sb and Bi. Thus, the first layer **212a** may include an Ag—Sb alloy or an Ag—Bi alloy.

The second layer **214** including a metal oxide excluding silver included in the first layer **212a** is arranged on the first layer **212a**. For example, the second layer **214** may be formed of antimony oxide (SbOx) or bismuth oxide (BiOx). That is, the second layer **214** is a metal oxide layer excluding silver included in the first layer **212a**. The second layer **214** prevents silver of the first layer **212a** from agglomerating on the first protective layer **215**.

The first protective layer **215** is formed on the second layer **214**. The first protective layer **215** includes transparent conductive oxide and protects the first layer **212a** including silver. Also, since the first protective layer **215** is formed of transparent conductive oxide having a high work function, the first electrode **210** including the first protective layer **215** may be used as an anode having a high efficiency.

The pixel defining layer **15** including the organic insulating layer covers the edges of the first electrode **210**. The intermediate layer **220** including the emission layer **221** is formed on the first electrode **210**. The second electrode **230** is formed on the intermediate layer **220**. Since materials and structures of the pixel defining layer **15**, the emission layer **221**, the intermediate layer **220**, and the second electrode **230** are the same as those of the embodiment shown in FIG. 1, detailed descriptions thereof are omitted here.

In the organic light-emitting display apparatus **2** according to the present embodiment, the second layer **214**, the oxide layer, that is arranged between the first protective layer **215** and the first layer **212a** that includes the silver and

non-silver metal alloy, prevents silver in the first layer **212a** effusing through a surface of the first protective layer **215**.

FIGS. **5A** and **5B** are cross-sectional views that partly illustrate a method of manufacturing the organic light-emitting display apparatus **2** of the second exemplary embodiment, according to an exemplary embodiment.

Referring to FIG. **5A**, the buffer layer **11** is formed on the substrate **10**. A layer including transparent conductive oxide, a layer including a silver and non-silver metal alloy, and another layer including transparent conductive oxide are sequentially deposited on the buffer layer **11**, and are patterned using the same mask, to form the first electrode **210** including the first protective layer **211**, the first layer **212a**, and the second protective layer **215**.

Each of the first protective layer **211** and the second protective layer **215** may include at least one material selected from the group consisting of ITO, IZO, ZnO, In₂O₃, IGO, and AZO. In an early stage of forming the first electrode **210**, each of the first protective layer **211** and the second protective layer **215** has an amorphous structure.

The first layer **212a** is formed of a silver and non-silver metal alloy. The non-silver metal material included in the silver and non-silver metal alloy of the first layer **212a** may include metal that is easily oxidized than silver and has an atomic radius that is less than or is similar to an atomic radius of silver. For example, the silver and non-silver metal alloy of the first layer **212a** may include at least one selected from Sb and Bi. Thus, the first layer **212a** may include an Ag—Sb alloy or an Ag—Bi alloy.

Referring to FIG. **5B**, an organic insulating layer is patterned so that the pixel defining layer **15** covering the edges of the first electrode **210** is formed. While a thermal treatment process such as a curing process is performed in a process of forming the pixel defining layer **15**, a non-silver metal in the alloy of the first layer **212a** effuses to a surface of the first layer **212a**. An atomic radius of Sb that is the group 15 element is 1.5 Å that is similar to 1.44 Å of an atomic radius of silver, thus, Sb included in the Ag—Sb alloy effuses to a surface of the Ag—Sb alloy during the thermal treatment process. Similarly, in a case of the Ag—Bi alloy that includes Bi having a similar feature to Sb, Bi effuses to a surface of the Ag—Bi alloy. As a result, in the first layer **212a** that is an alloy layer, density of Sb or Bi increases toward the second layer **214**.

Sb or Bi that effuses to the surface is naturally oxidized. Thus, the second layer **214** that is an oxide layer of Sb or Bi is formed between the first layer **212a** and the second protective layer **215**. As described above, the oxide layer is a protective layer for protecting the first layer **212a** including silver, and prevents effusion of silver through the surface of the second protective layer **215** and agglomeration of silver on the surface of the second protective layer **215**.

FIG. **6** is a graph that shows intensities of components in the first electrode **110** according to a sputtering time of the organic light-emitting display apparatus **1** shown in FIG. **1**.

A horizontal axis of the graph indicates the sputtering time, and a vertical axis of the graph indicates intensities of sputtered elements. Referring to FIG. **1** and FIG. **6**, in an early stage of sputtering, indium (In) and oxygen (O) components included in the first protective layer **111** and/or the second protective layer **115** were mainly detected, then non-silver metal oxide X-oxide was detected, and then silver (Ag) and non-silver metal X were detected (here, non-silver metal X is antimony or bismuth). That is, as illustrated in FIG. **6**, performing sputtering can check that the third layer **113** including non-silver metal X and the second layer **114** that is the oxide layer of the third layer **113** were formed

between the second protective layer **115** and the first layer **112** including silver. In the same manner, in case of the second exemplary embodiment as shown in FIG. **4**, it may be possible to check the second layer **214** that is the oxide layer of the non-silver metal X was formed between the second protective layer **215** and the first layer **212a** including a silver and non-silver metal X alloy.

As described above, the second layer **114**, **214** is a protective layer for protecting the first layer **112**, **212a** including silver, and prevents effusion of silver through the surface of the second protective layer **115**, **215** and agglomeration of silver on the surface of the second protective layer **115**.

As a result of the test performed in a reverse aging condition of at least 20 V, the first electrode **110** of FIG. **1** that was manufactured by using the method described with reference to FIGS. **2A** and **2B** has a 45% improvement in yield rate with respect to progressive dark spots, compared to the anode structure as illustrated in FIGS. **3A** and **3B**. As described above, the one or more of the above exemplary embodiments provide the organic light-emitting display apparatus having an improved display quality and an improved yield rate, and the method of manufacturing the organic light-emitting display apparatus.

Although certain exemplary embodiments and implementations have been described herein, other embodiments and modifications will be apparent from this description. Accordingly, the inventive concept is not limited to such embodiments, but rather to the broader scope of the presented claims and various obvious modifications and equivalent arrangements.

What is claimed is:

1. An organic light-emitting display apparatus, comprising:

a substrate;

a first electrode formed on the substrate;

an emission layer formed on the first electrode;

a second electrode formed on the emission layer,

wherein the first electrode comprises:

a first layer including silver (Ag);

a second layer disposed on the first layer and comprising an oxide of a non-silver metal; and

a second protective layer that is formed between the second layer and the emission layer and comprising transparent conductive oxide.

2. The organic light-emitting display apparatus of claim 1, wherein the non-silver metal comprises at least one selected from antimony (Sb) and bismuth (Bi).

3. The organic light-emitting display apparatus of claim 1, further comprising:

a third layer,

wherein the third layer is formed between the first layer and the second layer, and

wherein the third layer comprises the non-silver metal.

4. The organic light-emitting display apparatus of claim 1, further comprising:

a first protective layer,

wherein the first protective layer is formed between the substrate and the first layer, and

wherein the first protective layer comprises transparent conductive oxide.

5. The organic light-emitting display apparatus of claim 4, wherein the first protective layer comprises at least one material selected from the group consisting of indium tin oxide (ITO), indium zinc oxide (IZO), zinc oxide (ZnO), indium oxide (In₂O₃), indium gallium oxide (IGO), and aluminum zinc oxide (AZO).

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6. The organic light-emitting display apparatus of claim 1, wherein the second protective layer comprises at least one material selected from the group consisting of ITO, IZO, ZnO, In₂O₃, IGO, and AZO.

7. The organic light-emitting display apparatus of claim 1, wherein the first layer comprises the silver and the non-silver metal alloy.

8. The organic light-emitting display apparatus of claim 7, wherein the non-silver metal comprises at least one selected from antimony (Sb) and bismuth (Bi).

9. The organic light-emitting display apparatus of claim 1, wherein the second electrode is a reflective electrode.

10. The organic light-emitting display apparatus of claim 9, wherein light emitting from the emission layer is discharged toward the substrate.

11. The organic light-emitting display apparatus of claim 1, wherein the second electrode is a transparent electrode.

12. The organic light-emitting display apparatus of claim 11, wherein light emitting from the emission layer is discharged away from the substrate.

13. The organic light-emitting display apparatus of claim 1, wherein the first electrode is an anode, and the second electrode is a cathode.

14. A method of manufacturing an organic light-emitting display apparatus, the method comprising:

forming a first layer comprising silver on a substrate;
forming a second layer comprising a non-silver metal on the first layer;

forming a protective layer comprising transparent conductive oxide on the layer comprising the non-silver metal;

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forming an emission layer on the protective layer;
forming an electrode on the emission layer; and
forming, by performing a thermal treatment, a third layer comprising an oxide of the non-silver metal between the protective layer and the second layer.

15. The method of claim 14, wherein the second layer comprises at least one selected from antimony (Sb) and bismuth (Bi).

16. The method of claim 14, further comprising forming a fourth layer comprising a transparent conductive oxide between the substrate and the first layer.

17. A method of manufacturing an organic light-emitting display apparatus, the method comprising:

forming a first layer comprising an alloy of silver and a non-silver metal on a substrate;

forming a protective layer comprising a transparent conductive oxide on the first layer;

forming an emission layer on the protective layer;

forming a second electrode on the emission layer; and

forming, by performing a thermal treatment, a second layer comprising an oxide of the non-silver metal between the protective layer and the first layer.

18. The method of claim 17, wherein the non-silver metal comprises at least one selected from antimony (Sb) and bismuth (Bi).

19. The method of claim 17, further comprising:

forming a third layer comprising a transparent conductive oxide between the substrate and the first layer.

* * * * *

专利名称(译)	有机发光显示装置及其制造方法		
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摘要(译)

提供了一种有机发光显示装置，包括：基板；形成在所述基板上的第一电极；发射层，形成在所述第一电极上；以及形成在所述发射层上的第二电极，其中所述第一电极包括包含银（Ag）的第一层；以及设置在所述第一层上并包含非银金属氧化物的第二层。

